

# LCG150FFS120E2C

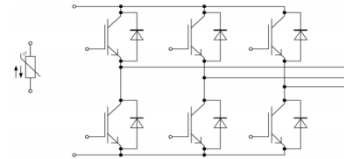
## 1200V, 150A 6-Pack Module

### Features

- Positive Temperature Co-efficient for Easy Parallel Operating
- Low  $V_{CE(sat)}$
- Low Switching Losses
- High Current Capability
- Short Circuit Rated

### Typical Applications

- Motor Drives
- UPS Systems
- High Frequency Switching Applications



### Maximum Ratings

Parameter	Symbol	Conditions		Value	Unit
Collector to emitter voltage	$V_{CES}$			1200	V
Gate to emitter voltage	$V_{GES}$			$\pm 20$	V
DC collector current	$I_C$	Continuous	$T_C = 25^\circ\text{C}$	240	A
		Continuous	$T_C = 90^\circ\text{C}$	150	A
	$I_{CM}$	$t_p = 1\text{ ms}$	300	A	
Operating junction temperature, IGBT	$T_{Jop}$			150	$^\circ\text{C}$
Maximum junction temperature	$T_{Jmax}$			175	$^\circ\text{C}$
Maximum power dissipation	$P_D$	1 device	$T_J = 175^\circ\text{C}$	789	W
Repetitive peak reverse voltage	$V_{RRM}$			1200	V
Continuous DC forward current	$I_F$			150	A
Repetitive peak forward current	$I_{FRM}$			300	A
Operating junction temperature, Diode	$T_{Jop}$			150	$^\circ\text{C}$
Case temperature	$T_C$			125	$^\circ\text{C}$
Storage temperature	$T_{stg}$			150	$^\circ\text{C}$

### Thermal Characteristics

Parameter	Symbol	Min	Typ	Max	Unit
Thermal resistance, junction to case, per IGBT	$R_{thJC}$	-	-	0.19	K/W
Thermal resistance, junction to case, per Diode	$R_{thJC}$	-	-	0.32	K/W

**Inverter Electrical Characteristics** ( $T_J = 25^\circ\text{C}$  unless otherwise specified)

Parameter	Symbol	Test Conditions		Min	Typ	Max	Unit	
Collector-emitter breakdown voltage	$BV_{CES}$	$V_{GE} = 0\text{ V}, I_C = 1\text{ mA}$		1200	-	-	V	
Collector-emitter cutoff current	$I_{CES}$	$V_{GE} = 0\text{ V}, V_{CE} = V_{CES}$		-	-	1	mA	
Gate leakage current	$I_{GES}$	$V_{CE} = 0\text{ V}, V_{GE} = V_{GES}$		-	-	$\pm 100$	nA	
Gate emitter threshold Voltage	$V_{GE(th)}$	$V_{GE} = V_{CE}, I_C = 5.7\text{ mA}$		5.2	5.8	6.5	V	
Internal gate resistor	$R_G$	$f = 1\text{ MHz}$	$T_J = 25^\circ\text{C}$	-	5	-	$\Omega$	
Collector-emitter Saturation Voltage	$V_{CE(sat)}$	$I_C = 150\text{ A}, V_{GE} = 15\text{ V}$		-	1.8	2.2	V	
		$I_C = 150\text{ A}, V_{GE} = 15\text{ V}$	$T_J = 125^\circ\text{C}$	-	2.05	-	V	
		$I_C = 150\text{ A}, V_{GE} = 15\text{ V}$	$T_J = 150^\circ\text{C}$	-	2.1	-	V	
Input capacitance	$C_{ies}$	$V_{GE} = 0\text{ V}, V_{CE} = 25\text{ V}, f = 1\text{ MHz}$		-	12.6	-	nF	
Reverse transfer capacitance	$C_{res}$			-	0.43	-		
Total gate charge	$Q_g$	$V_{CE} = 600\text{ V}, I_C = 150\text{ A},$ $V_{GE} = -15\text{ V} \dots +15\text{ V}$		-	1.5	-	$\mu\text{C}$	
Turn-on delay time	$t_{d(on)}$	$V_{CC} = 600\text{ V}, I_C = 150\text{ A}$ $V_{GE} = \pm 15\text{ V}$ $R_{Gon} = 1.1\ \Omega, R_{Goff} = 1.1\ \Omega$		$T_J = 25^\circ\text{C}$	-	0.14	-	$\mu\text{s}$
				$T_J = 125^\circ\text{C}$	-	0.14	-	$\mu\text{s}$
				$T_J = 150^\circ\text{C}$	-	0.15	-	$\mu\text{s}$
Rise time	$T_r$			$T_J = 25^\circ\text{C}$	-	0.04	-	$\mu\text{s}$
				$T_J = 125^\circ\text{C}$	-	0.05	-	$\mu\text{s}$
				$T_J = 150^\circ\text{C}$	-	0.05	-	$\mu\text{s}$
Turn-off delay time	$T_{d(off)}$			$T_J = 25^\circ\text{C}$	-	0.23	-	$\mu\text{s}$
				$T_J = 125^\circ\text{C}$	-	0.28	-	$\mu\text{s}$
				$T_J = 150^\circ\text{C}$	-	0.30	-	$\mu\text{s}$
Fall time	$T_f$			$T_J = 25^\circ\text{C}$	-	0.14	-	$\mu\text{s}$
		$T_J = 125^\circ\text{C}$	-	0.18	-	$\mu\text{s}$		
		$T_J = 150^\circ\text{C}$	-	0.19	-	$\mu\text{s}$		
Turn-on switching loss	$E_{on}$	$T_J = 25^\circ\text{C}$	-	4.6	-	mJ		
		$T_J = 125^\circ\text{C}$	-	5.9	-	mJ		
		$T_J = 150^\circ\text{C}$	-	6.6	-	mJ		
Turn-off switching loss	$E_{off}$	$T_J = 25^\circ\text{C}$	-	9.1	-	mJ		
		$T_J = 125^\circ\text{C}$	-	13.5	-	mJ		
		$T_J = 150^\circ\text{C}$	-	14.5	-	mJ		
Short circuit data	$I_{sc}$	$V_{GE} = 15\text{ V}, V_{CC} = 800\text{ V}$ $V_{CEmax} = V_{CES} - L_{sCE} \cdot di/dt$ $t_p \leq 10\ \mu\text{s}$		$T_J = 150^\circ\text{C}$	-	600	-	A

**Inverter Electrical Characteristics** ( $T_J = 25^\circ\text{C}$  unless otherwise specified)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit	
Forward voltage	$V_F$	$I_F = 150\text{ A}$	$T_J = 25^\circ\text{C}$	-	2.1	2.5	V
			$T_J = 125^\circ\text{C}$	-	1.8	-	V
Peak reverse recovery current	$I_{rr}$	$I_F = 150\text{ A}, V_R = 600\text{ V}$ $V_{GE} = -15\text{ V}, R_{Gon} = 1.1\ \Omega$	$T_J = 25^\circ\text{C}$	-	180	-	A
			$T_J = 125^\circ\text{C}$	-	187	-	A
Reverse recovery charge	$Q_{rr}$	$I_F = 150\text{ A}, V_R = 600\text{ V}$ $V_{GE} = -15\text{ V}, R_{Gon} = 1.1\ \Omega$	$T_J = 25^\circ\text{C}$	-	15.1	-	$\mu\text{C}$
			$T_J = 125^\circ\text{C}$	-	25.0	-	$\mu\text{C}$
Reverse recovery energy	$E_{rec}$	$I_F = 150\text{ A}, V_R = 600\text{ V}$ $V_{GE} = -15\text{ V}, R_{Gon} = 1.1\ \Omega$	$T_J = 25^\circ\text{C}$	-	3.7	-	mJ
			$T_J = 125^\circ\text{C}$	-	9.4	-	mJ

**Electrical Characteristics** ( $T_J = 25^\circ\text{C}$  unless otherwise specified)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit		
NTC	Rated resistance	$R_{25}$	$T_C = 25^\circ\text{C}$	-	5	-	$\text{k}\Omega$	
	Deviation of $R_{100}$	$\Delta R/R$	$R_{100} = 493\ \Omega$	$T_J = 100^\circ\text{C}$	-5	-	5	%
	Power dissipation	$P_{25}$	$T_C = 25^\circ\text{C}$	-	-	20	mW	
	B-value	$B_{25/50}$	$R_2 = R_{25} \exp [B_{25/50}(1/T_2 - 1/(298.15\text{ K}))]$	-	3375	-	W	

**Electrical Characteristics** ( $T_J = 25^\circ\text{C}$  unless otherwise specified)

Parameter	Symbol	Test Conditions	Value	Unit	
Module	Isolation test voltage	$V_{ISOL}$	RMS, $f = 50\text{ Hz}$ , $t = 1\text{ min.}$	2.5	kV
	Material of module baseplate			Cu	
	Internal isolation		basic insulation (class 1, IEC 61140)	$\text{Al}_2\text{O}_3$	
	Creepage distance		terminal to heatsink	10	mm
			terminal to terminal		
	Clearance		terminal to heatsink	7.5	mm
			terminal to terminal		
	Comperative tracking index	CTI		>200	
	Thermal resistance, case to heatsink	$R_{thCH}$	per module, $\lambda_{grease} = 1\text{ W}/(\text{m}\cdot\text{K})$	0.01	K/W
	Stray inductance module	$L_{sCE}$		20	nH
	Module lead resistance, terminals - chip	$R_{CC+EE}$	per switch	1.8	$\text{m}\Omega$
	Mounting torque for module mounting	M	Screw M5	3-6	Nm
	Weight	G		300	g

Fig 1, Output Characteristics IGBT, Inverter (typical)

$I_C = f(V_{CE})$   
 $V_{GE} = 15\text{ V}$

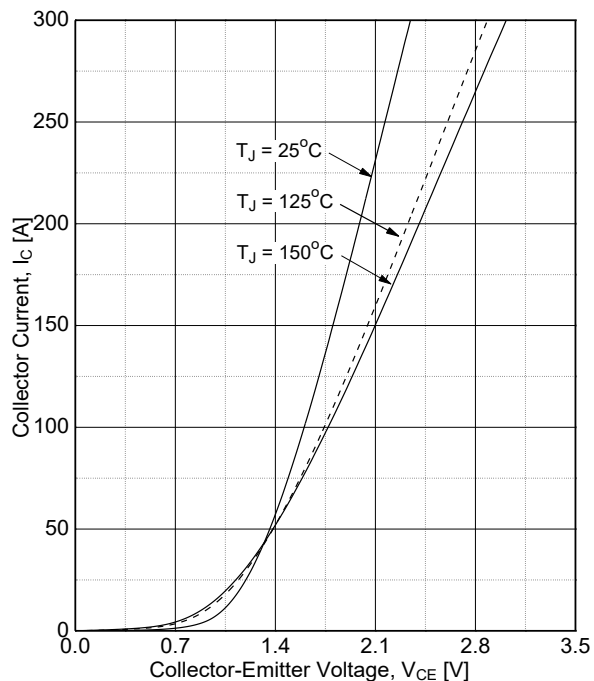


Fig 2, Output Characteristics IGBT, Inverter (typical)

$I_C = f(V_{CE})$   
 $T_J = 150^\circ\text{C}$

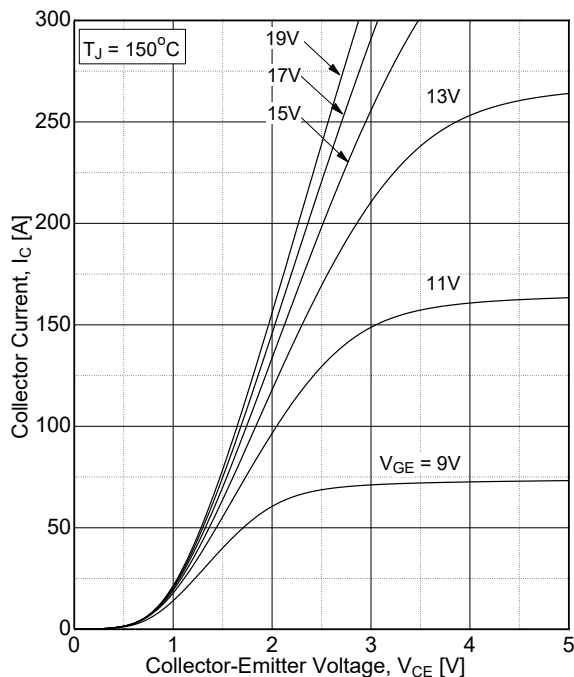


Fig 3, Transfer Characteristics IGBT, Inverter (typical)

$I_C = f(V_{GE})$   
 $V_{CE} = 20\text{ V}$

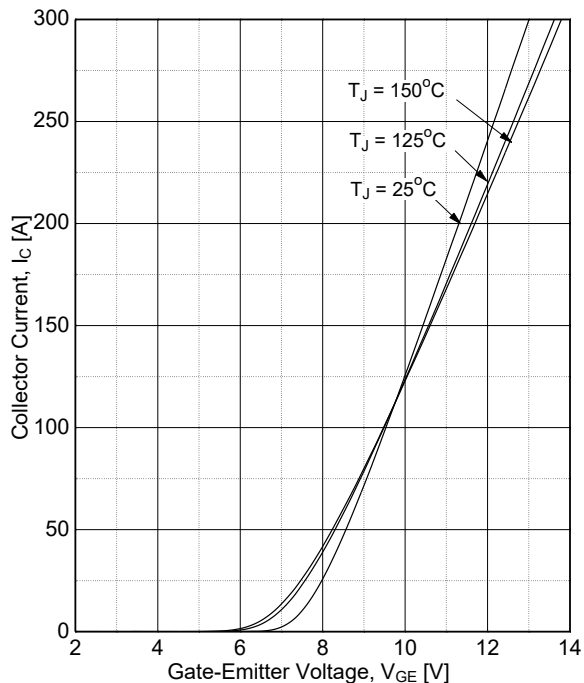


Fig 4, Switching Losses IGBT, Inverter (typical)

$E_{on} = f(I_C), E_{off} = f(I_C)$   
 $V_{GE} = \pm 15\text{ V}, R_{gon} = 1.1\ \Omega, R_{goff} = 1.1\ \Omega, V_{CE} = 600\text{ V}$

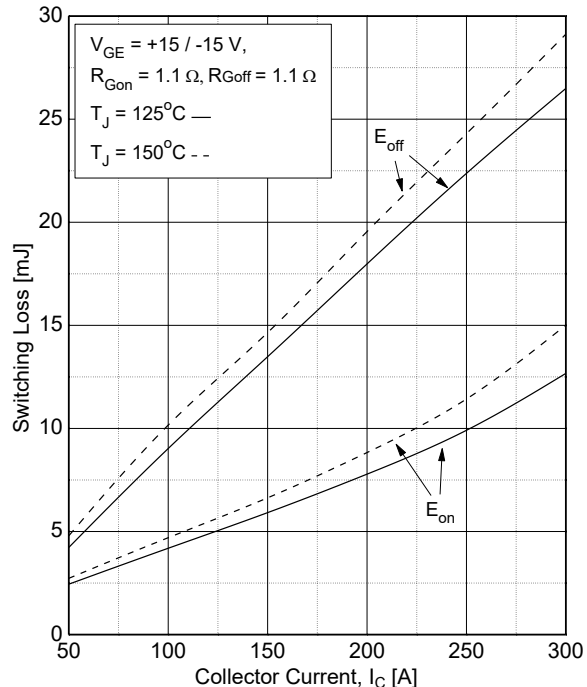


Fig 5, Switching Losses IGBT, Inverter (typical)

$E_{on} = f(R_G)$ ,  $E_{off} = f(R_G)$

$V_{GE} = +/-15\text{ V}$ ,  $I_{CE} = 150\text{ A}$ ,  $V_{CE} = 600\text{ V}$

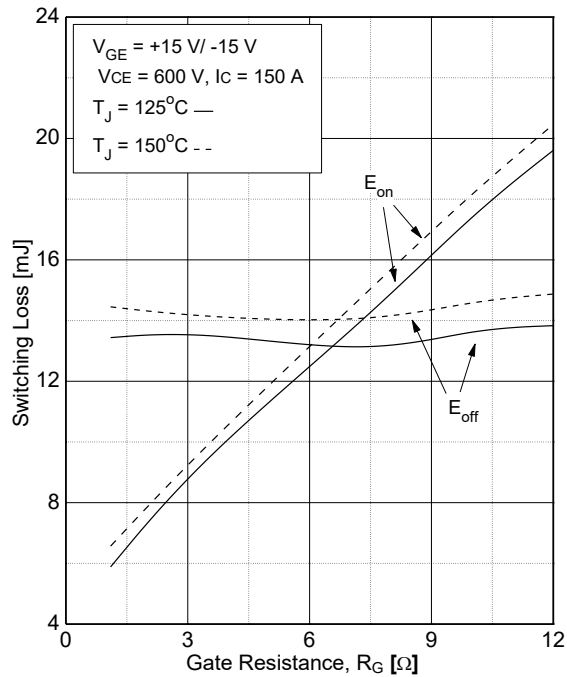


Fig 6, Transient Thermal Impedance IGBT, Inverter

$Z_{thJC} = f(t)$

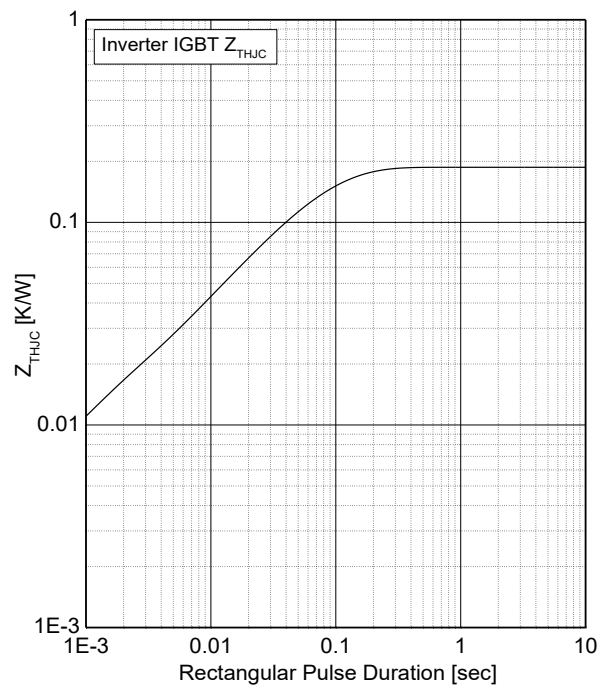


Fig 7, Reverse Bias safe operating area IGBT, Inverter (RBSOA)

$I_C = f(V_{CE})$

$V_{GE} = +/-15\text{ V}$ ,  $R_{Goff} = 1.1\ \Omega$ ,  $T_J = 150^\circ\text{C}$

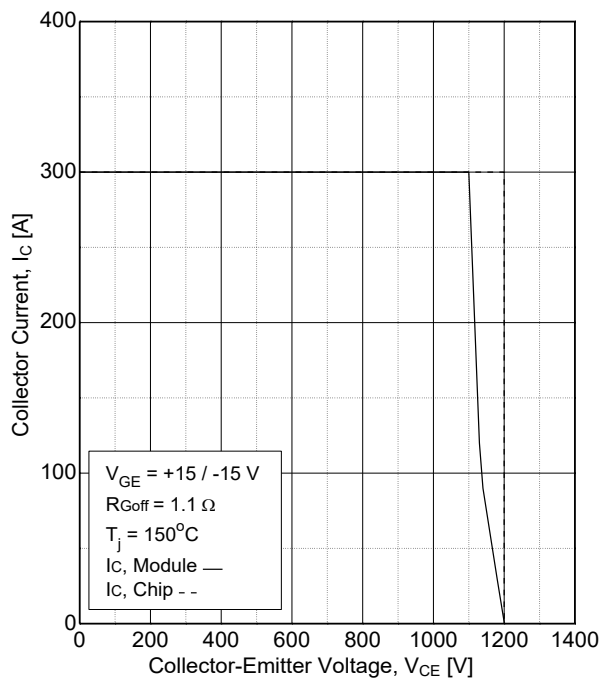


Fig 8, Forward Characteristics of Diode, Inverter (typical)

$I_F = f(V_F)$

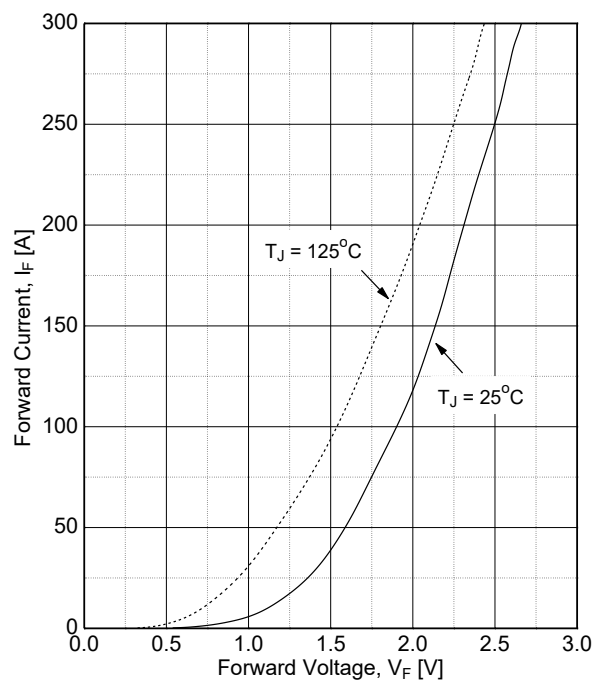


Fig 9, Switching Losses Diode, Inverter (typical)

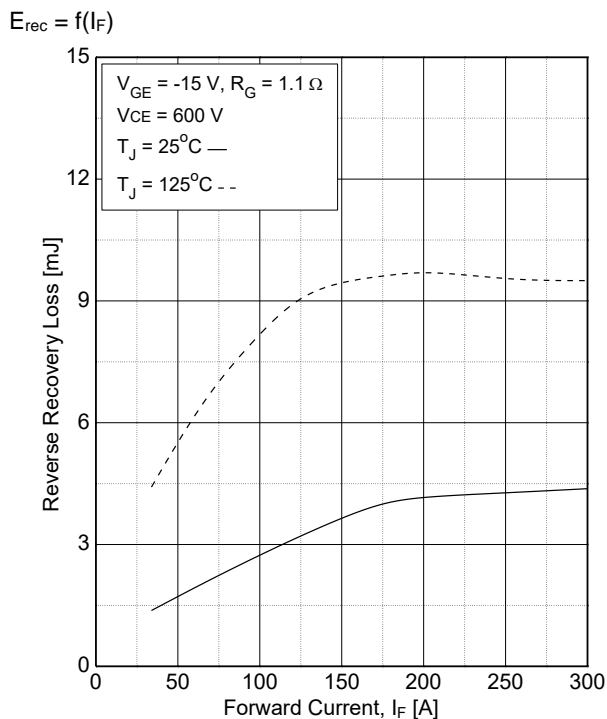


Fig 10, Switching Losses Diode, Inverter (typical)

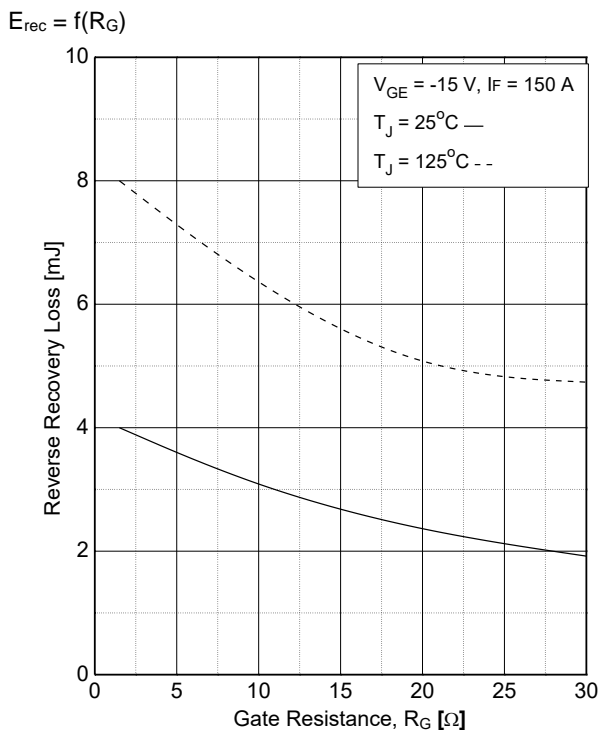


Fig 11, Transient Thermal Impedance Diode, Inverter

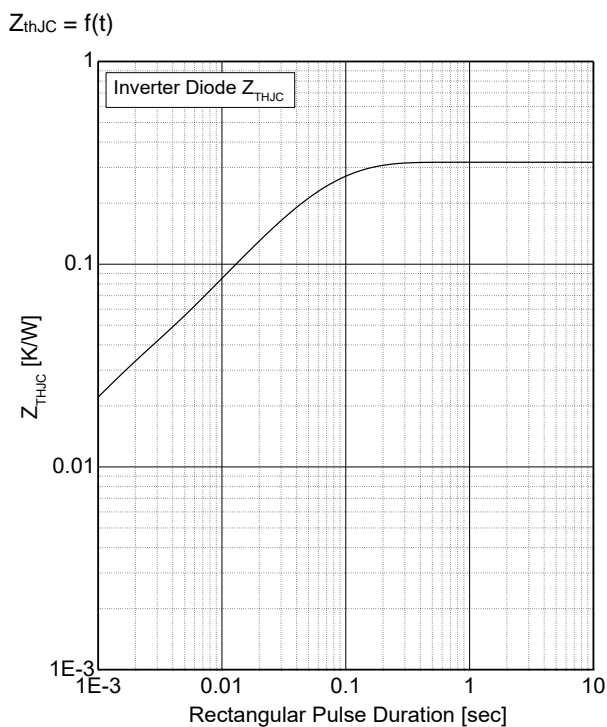
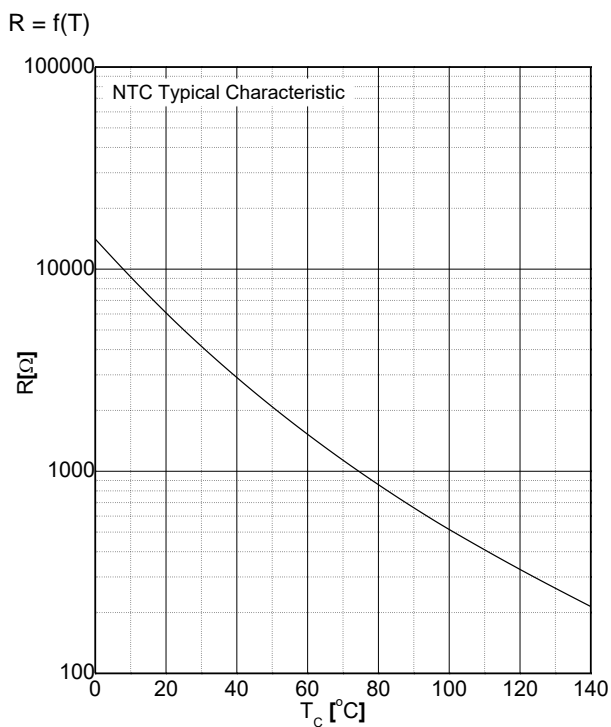
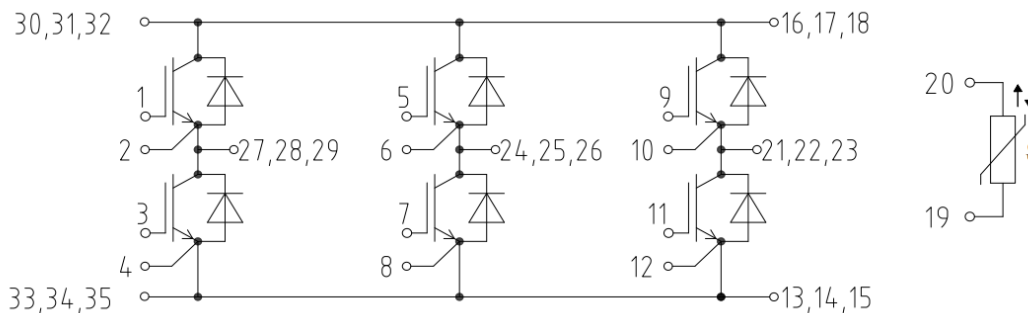


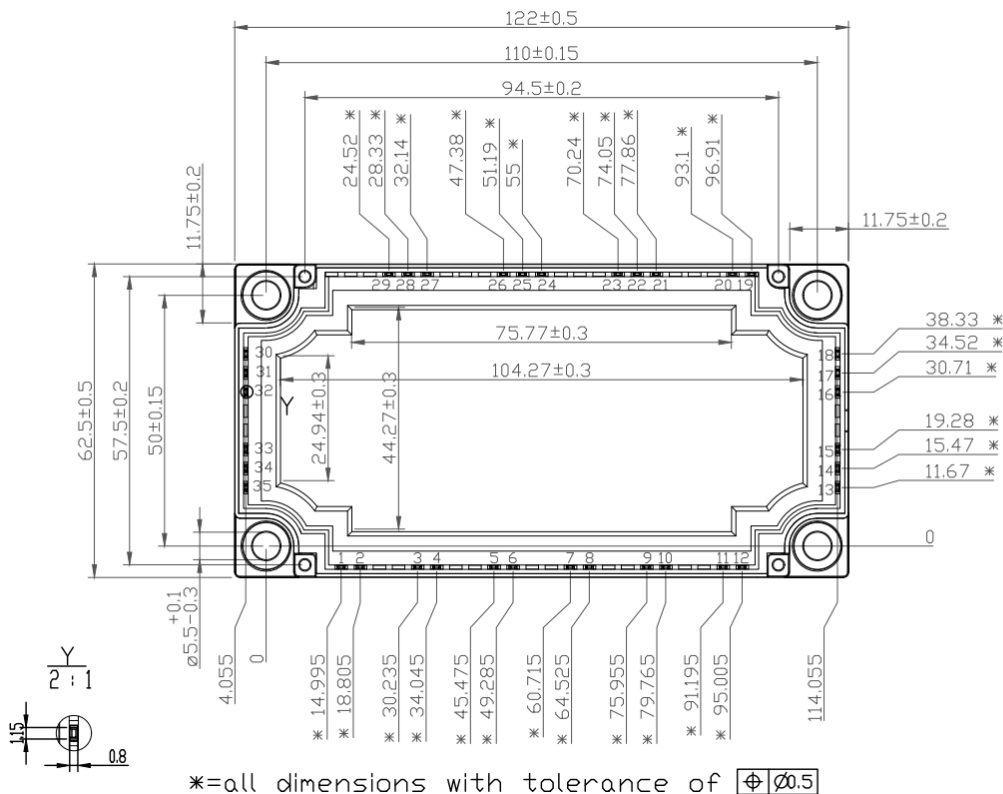
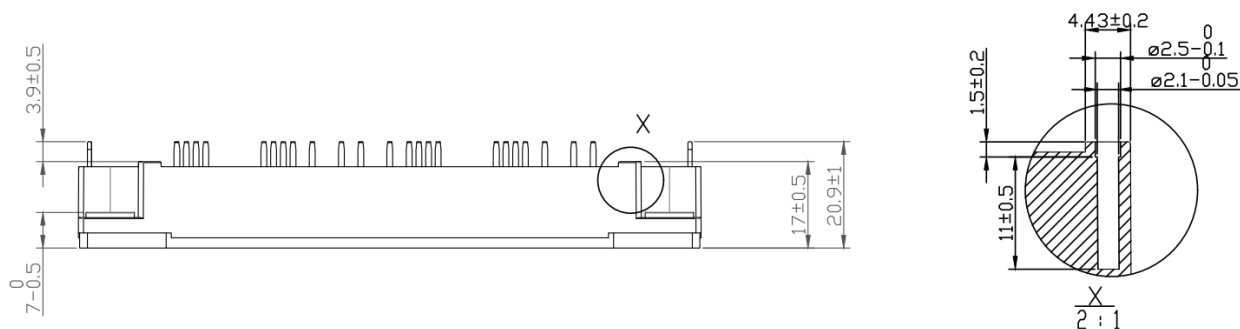
Fig 12, NTC Characteristics (typical)



Circuit Diagram



Package Outlines



**Revisions History**

<b>Version</b>	<b>Description of Change</b>	<b>Date</b>
1.0	Preliminary Datasheet	Nov.2. 2019
2.0	Final Datasheet	May.18. 2020